

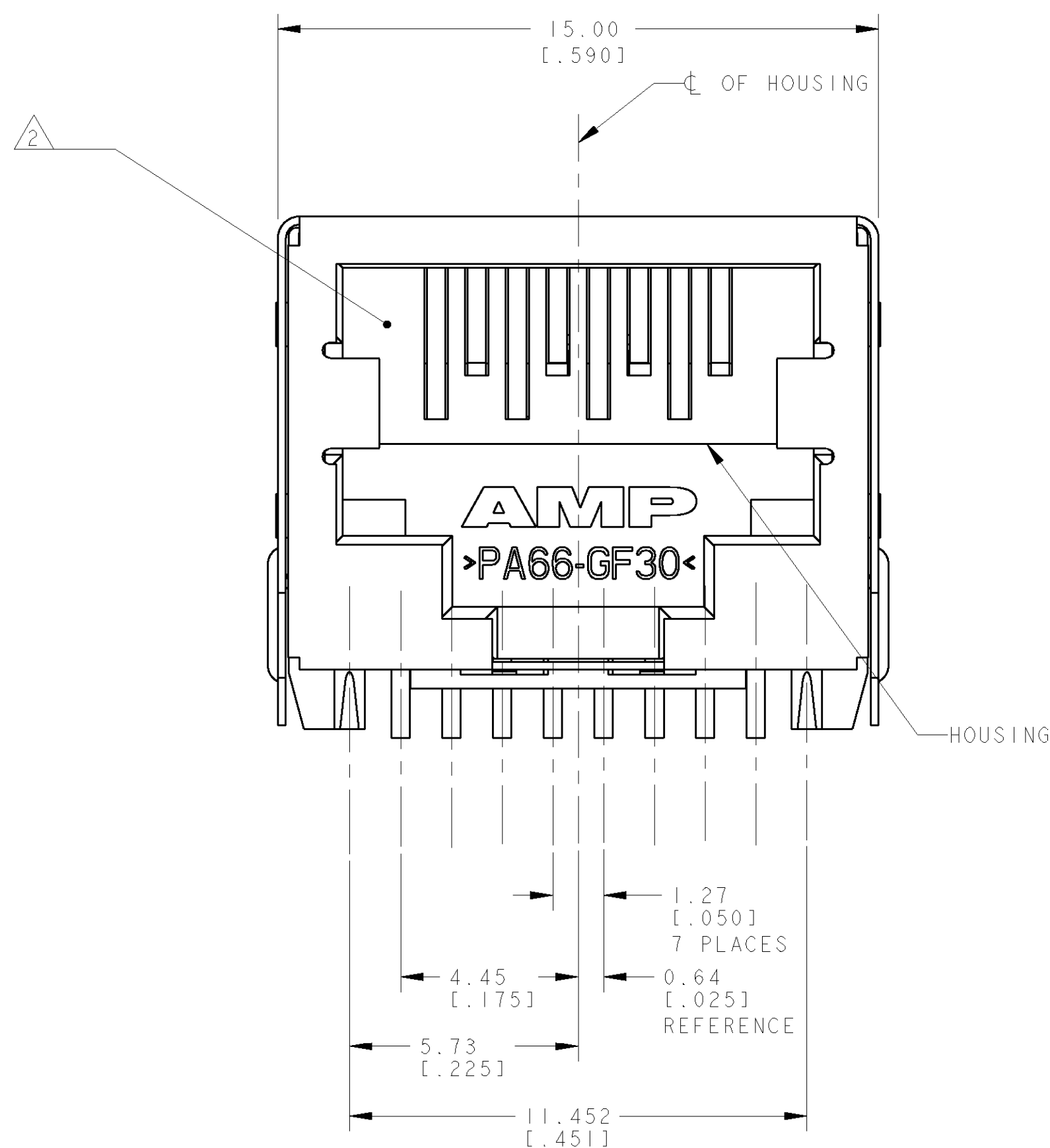
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Jameco Part Number 896783



△ MATERIAL: HOUSING - HIGH TEMPERATURE NYLON, BLACK, UL 94V-0,
IR REFLOW SOLDERING PROCESS COMPATIBLE
TERMINALS - 0.25[.01] THICK PHOSPHOR BRONZE PLATED WITH
3.81μm[.000150] MINIMUM THICK BRIGHT TIN-LEAD IN SOLDER AREA
AREA, 1.27μm[.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA.
ENTIRE TERMINAL PLATED WITH 1.27μm[.000050] MINIMUM THICK
NICKEL.
SHIELD - 0.1[.0039] MIN THICK COPPER ZINC ALLOY, PREPLATED WITH
2.03μm - 3.81μm[.000080-.000150] THICK TIN-LEAD OVER 2.54μm
[.00010] MIN THICK COPPER.

2 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68,
SUBPART F.

 THIS DIMENSION REPRESENTS THE TOTAL HEIGHT OF THE CONNECTOR FROM THE TOP OF THE PC BOARD.

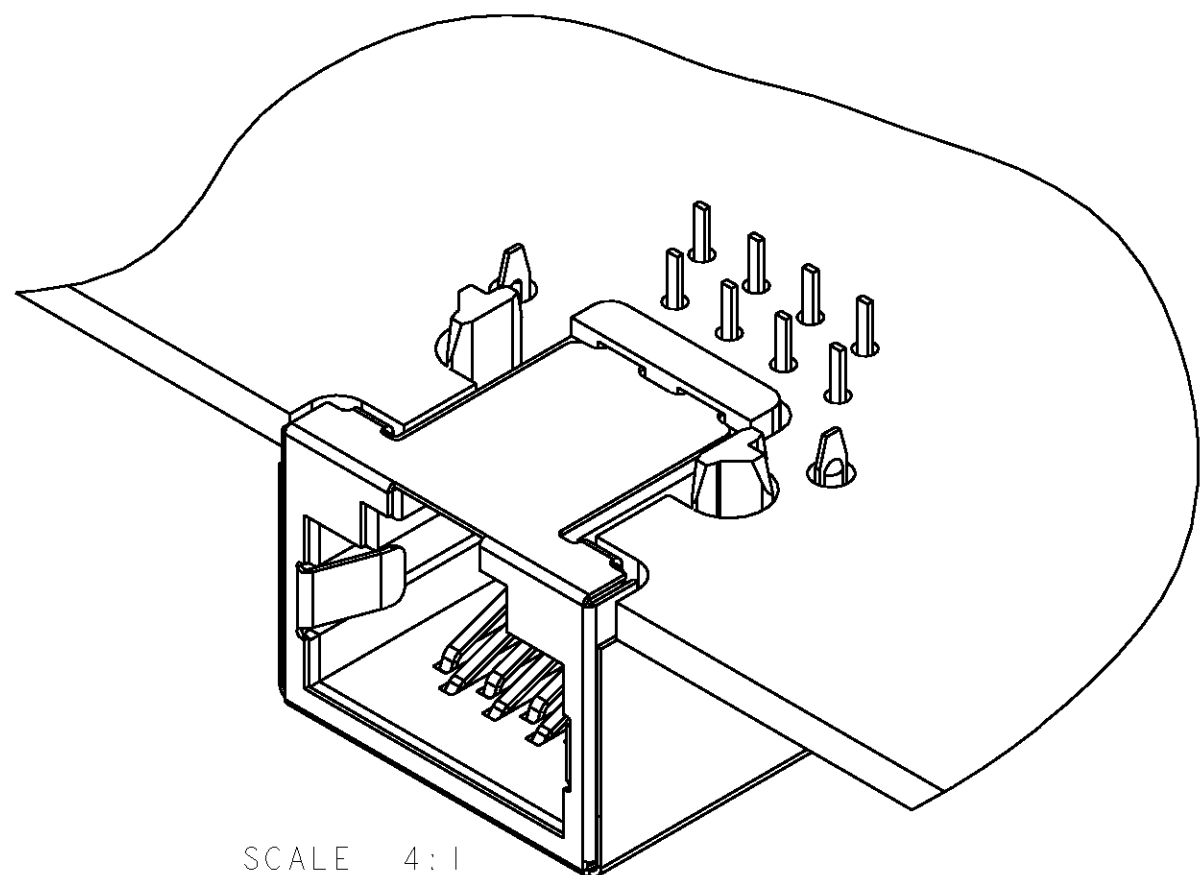
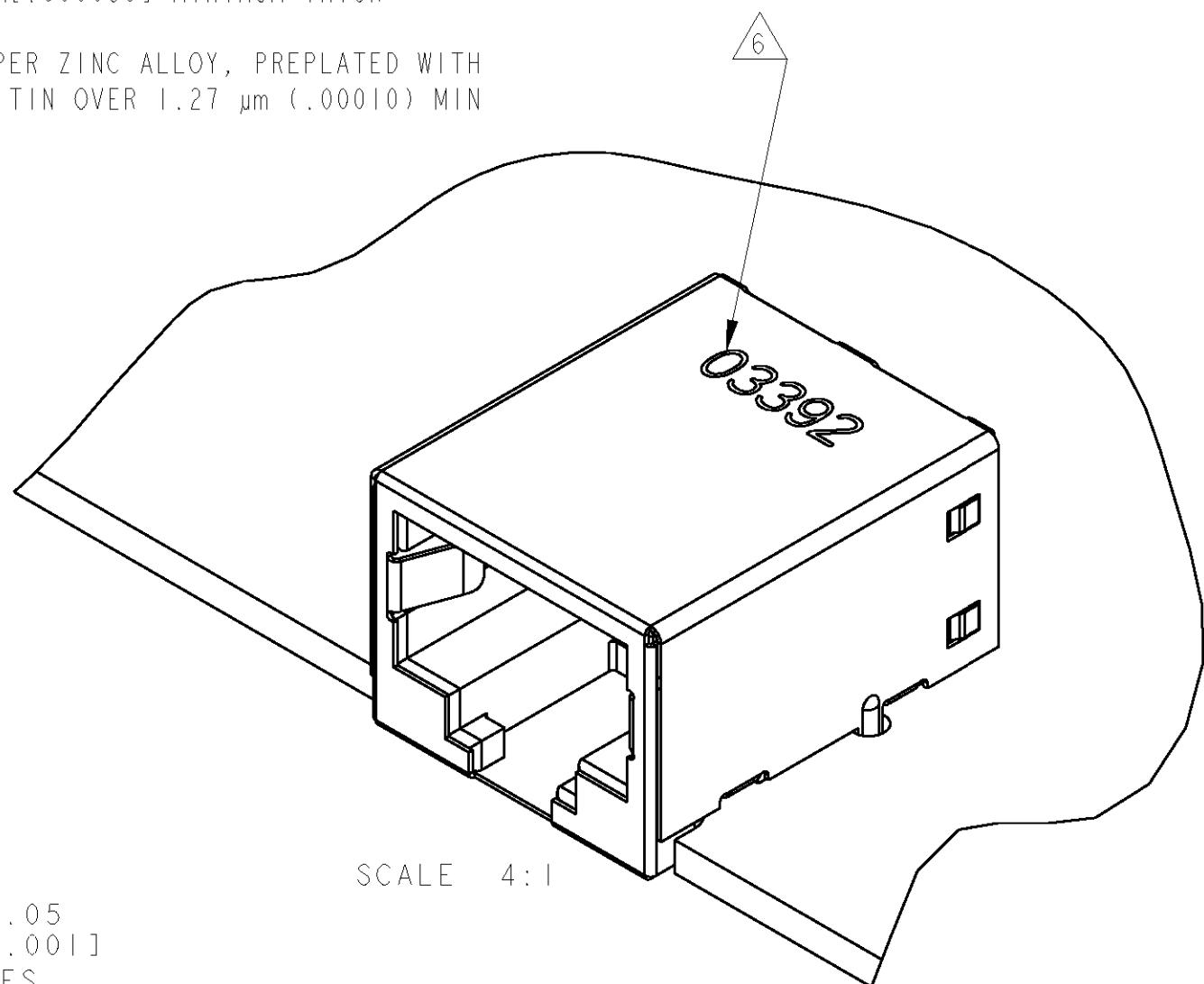
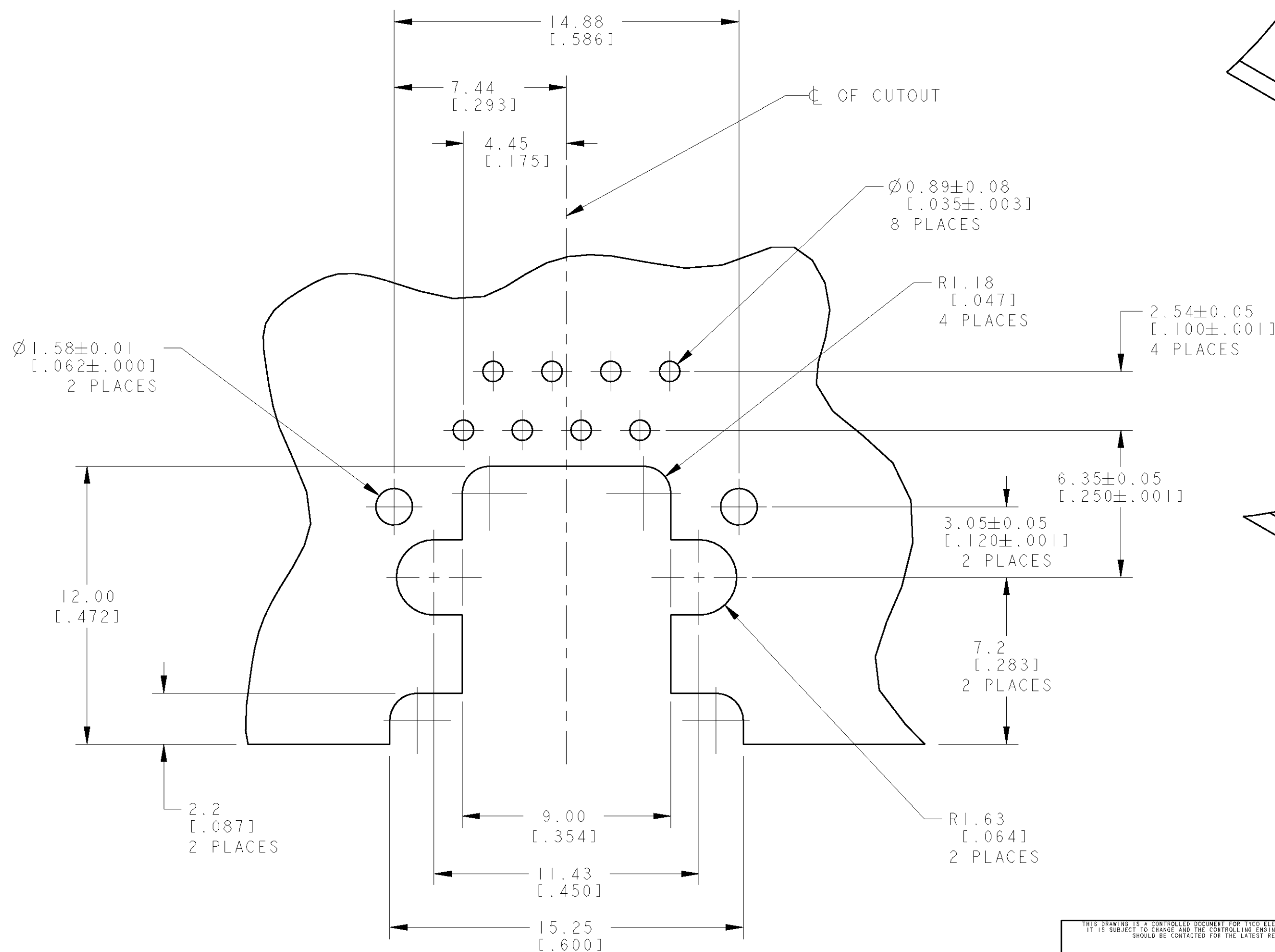
4. PACKAGED 66 ASSEMBLIES PER PVC TRAY, 396 PER BOX.

5. DIELECTRIC WITHSTANDING VOLTAGE BETWEEN SHIELD AND
TERMINAL IS 1500 VAC

MANUFACTURING DATE CODE:
ORIENTED AND LOCATED APPROXIMATELY AS SHOWN. BLACK INK STAMP.
TEXT HEIGHT APPROXIMATELY 2MM.

FIRST 2 DIGITS = LAST 2 DIGITS OF YEAR
NEXT 2 DIGITS = MANUFACTURING WORK WEEK
LAST DIGIT = DAY OF WEEK WITH SUNDAY = 1

△ MATERIAL: HOUSING - HIGH TEMPERATURE NYLON, BLACK, UL 94V-0,
1R REFLOW SOLDERING PROCESS COMPATIBLE
TERMINALS - 0.25[.01] THICK PHOSPHOR BRONZE PLATED WITH
3.81 μ m(.000150) MINIMUM THICK BRIGHT TIN IN SOLDER AREA
AREA, 1.27 μ m(.000050) MINIMUM GOLD IN LOCALIZED PLATE AREA.
ENTIRE TERMINAL PLATED WITH 1.27 μ m(.000050) MINIMUM THICK
NICKEL.
SHIELD - 0.1[.0039] MIN THICK COPPER ZINC ALLOY, PREPLATED WITH
2.0-4.0 μ m(.000079-.000157) THICK TIN OVER 1.27 μ m(.00010) MIN
THICK NICKEL



SECTION A - A

SUGGESTED PANEL CUTOUT
SCALE 4:1

SUGGESTED PRINTED CIRCUIT
BOARD LAYOUT
COMPONENT SIDE
SCALE 6:1

DIMENSIONS: mm [INCHES] 		TOLERANCES, UNLESS OTHERWISE SPECIFIED: 9 PLOC ± 2 PLOC ± 2 PLOC ±0.13C (.005) 3 PLOC ± 1 PLOC ± ANGLES ± FINISH		DWG. J. AHERON 07APR99 CHK. D. KEMPKA 07APR99 APPR. D. KEMPKA 07APR99 PRODUCT SPEC 108-1163 APPLICATION SPEC 114-2048 WEIGHT 3.49 grams		tyco Electronics Tyco Electronics Harrisburg, PA 17105-3608	
MATERIAL SEE P/N TABLE		SEE P/N TABLE		NAME MODULAR JACK ASSEMBLY, 8 POSITION, SHIELDED, 10mm WITHOUT PANEL TABS SIZE CASE CODE DRAWING NO. A 00779 C=1116503 CUSTOMER DRAWING		RESTRICTED TO - SCALE 8:1 SHEET 1 OF 1 REV K	